

Programmable High Frequency Crystal Oscillator with Spread Spectrum (SSXO) and No Spread Spectrum (XO) Option

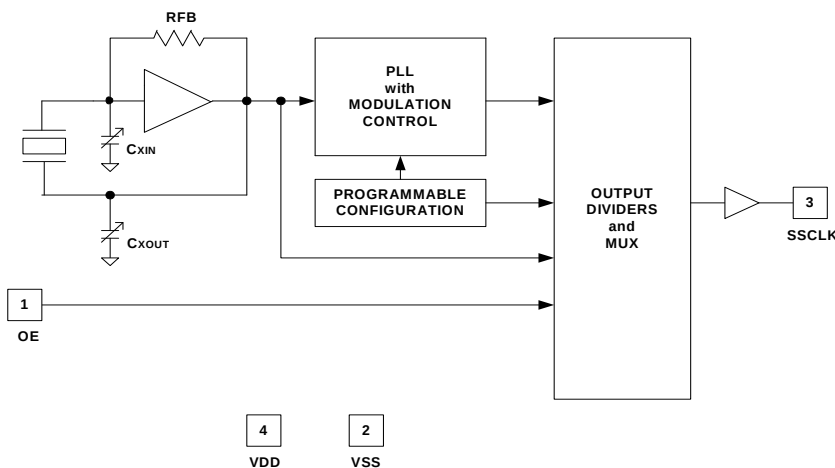
Features

- Crystal Oscillator with Spread Spectrum Clock (SSXO)
- No Spread Spectrum (XO) Option
- Wide operating output clock frequency range of 10 –166 MHz
- Programmable spread spectrum with nominal 31.5 kHz modulation frequency
- Center spread: $\pm 0.25\%$ to $\pm 2.0\%$
- Down spread: -0.5% to -4.0%
- No spread: $\pm 0.0\%$
- Integrated phase-locked loop (PLL)
- 85 ps typical cycle-to-cycle jitter with SSCLK = 133 MHz
- 3.3V operation
- Output enable function
- Package available in 4-Pin ceramic LCC SMD
- Pb-free package
- Industrial temperature from -40°C to 85°C

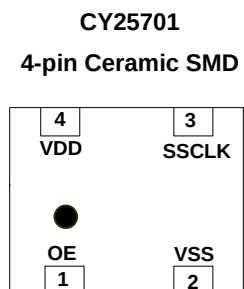
Benefits

- Provides a wide range of spread percentages for maximum electromagnetic interference (EMI) reduction to meet regulatory agency electromagnetic compliance (EMC) requirements. Reduces development and manufacturing costs and time-to-market.
- This versatile programming feature enables the user to switch between SSXO (with Spread) and XO (without Spread) functions with ease.
- Internal PLL to generate up to 166 MHz output.
- Suitable for most PC, consumer, and networking applications
- Application compatibility in standard and low-power systems
- In house programming of samples and prototype quantities is available using CY3672 programming kit and CY3724 socket adapters. Production quantities are available through Cypress' value added distribution partners or by using third party programmers from BP Microsystems, and HiLo Systems, and others.

Logic Block Diagram



Pin Configuration



Pin Definition

Pin	Name	Description
1	OE	Output Enable pin: Active HIGH. If OE = 1, SSCLK is enabled
2	VSS	Power supply ground
3	SSCLK	Spread spectrum clock output (with or without spread)
4	VDD	3.3V power supply

Functional Description

The CY25701 is a Spread Spectrum Crystal Oscillator (SSXO) IC used to reduce the EMI found in today's high speed digital electronic systems.

The device uses a Cypress proprietary PLL and Spread Spectrum Clock (SSC) technology to synthesize and modulate the frequency of the embedded input crystal. By frequency modulating the clock, the measured EMI at the fundamental and harmonic frequencies are greatly reduced. This reduction in radiated energy can significantly reduce the cost of complying with regulatory agency (EMC) requirements and improve time-to-market without degrading system performance.

The CY25701 uses a programmable configuration memory array to synthesize output frequency and spread%.

The spread percentage is programmed to either center spread or down spread with various spread percentages. The range for center spread is from $\pm 0.25\%$ to $\pm 2.00\%$. The range for down spread is from -0.5% to -4.0% . Contact the factory for smaller or larger spread percentage amounts if required. Refer to [Table 2](#) for spread selection and no spread values.

The frequency modulated SSCLK output is programmable from 10 to 166 MHz.

The CY25701 is available in a 4-pin ceramic SMD package with an operating temperature range of -40 to 85°C .

Programming Description

Factory and Field Programmable CY25701

Factory and field programming is available for samples and manufacturing by Cypress and its distributors. Submit your request to the local Cypress Field Application Engineer (FAE) or sales representative. Once the request is processed, you will receive a new part number, samples, and data sheet with the programmed values. This part number is used for additional sample request and the production orders. Contact your local Cypress FAE or sales representative for details.

Additional information on the CY25701 is available at the Cypress web site www.cypress.com.

Output Frequency, SSCLK Output (SSCLK, pin 3)

The modulated frequency at the SSCLK output is produced by synthesizing from the embedded crystal oscillator frequency input. The range of synthesized clock is from 10 to 166 MHz.

Spread Percentage (SSCLK, pin 3)

The SSCLK spread is programmable to various spread percentage values from $\pm 0.25\%$ to $\pm 2.0\%$ for center spread and from -0.5% to -4.0% for down spread. Refer to [Table 2](#) for available spread options. Enter $\pm 0.0\%$ (No spread) for XO (crystal oscillator) without spread option.

Frequency Modulation (SSCLK, pin 3)

The default frequency modulation is programmed at 31.5 kHz for all SSCLK frequencies from 10 to 166 MHz. Alternate frequency modulations at 30.1 kHz or 32.9 kHz are selectable using CyberClocksOnline™ software. Contact the factory for other alternate modulation frequencies if required.

Table 1. Programming Data Requirement

Pin Function	Output Frequency	Spread Percent Code ^[1]	Frequency Modulation
Pin Name	SSCLK	SSCLK	SSCLK
Pin#	3	3	3
Units	MHz	%	kHz
Program Value	ENTER DATA	ENTER DATA	ENTER DATA 31.5

Note

- $\pm 0.0\%$ or Code "Z" for XO (No-Spread) option.

Table 2. Spread Percent Selection

Center Spread	Code	A	B	C	D	E	F	Z
	Percentage	±0.25%	±0.5%	±0.75%	±1.0%	±1.5%	±2.0%	±0.0%
Down Spread	Code	G	H	J	K	L	M	Z
	Percentage	−0.5%	−1.0%	−1.5%	−2.0%	−3.0%	−4.0%	±0.0%

Absolute Maximum Ratings

Supply Voltage (VDD).....−0.5V to +7.0V
 DC Input Voltage −0.5V to V_{DD} + 0.5V

Storage Temperature (Non-condensing) −55°C to +100°C
 Junction Temperature −40°C to +125°C
 Data Retention @ T_j = 125°C >10 years
 Package Power Dissipation 350 mW

Operating Conditions

Parameter	Description	Min	Typ	Max	Unit
V _{DD}	Supply voltage	3.00	3.30	3.60	V
T _A	Ambient temperature (commercial)	−20	−	70	°C
T _A	Ambient temperature (industrial)	−40	−	85	°C
C _{LOAD}	Max. load capacitance @ pin 3	−	−	15	pF
F _{SSCLK}	SSCLK output frequency, C _{LOAD} = 15 pF	10	−	166	MHz
F _{MOD}	Spread Spectrum Modulation Frequency	30.0	31.5	33.0	kHz
T _{PU}	Power up time for VDD to reach minimum specified voltage (power ramp must be monotonic)	0.05	−	500	ms

DC Electrical Characteristics

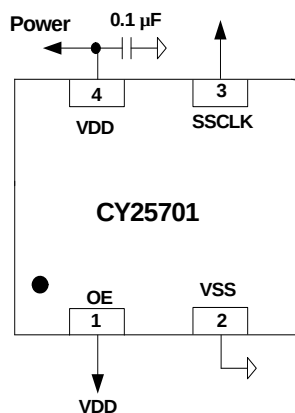
Parameter	Description	Condition	Min	Typ	Max	Unit
I _{OH}	Output high current (pin 3)	V _{OH} = V _{DD} − 0.5, V _{DD} = 3.3V (source)	10	12	−	mA
I _{OL}	Output low current (pin 3)	V _{OL} = 0.5, V _{DD} = 3.3V (sink)	10	12	−	mA
V _{IH}	Input high voltage (pin 1)	CMOS levels, 70% of V _{DD}	0.7V _{DD}	−	V _{DD}	V
V _{IL}	Input low voltage (pin 1)	CMOS levels, 30% of V _{DD}	−	−	0.3V _{DD}	V
I _{IH}	Input high current (pin 1)	V _{in} = V _{DD}	−	−	10	μA
I _{IL}	Input low current (pin 1)	V _{in} = V _{SS}	−	−	10	μA
I _{OZ}	Output leakage current (pin 3)	Three-state output, OE = 0	−10	−	10	μA
C _{IN} ^[2]	Input capacitance (pin 1)	Pin 1, or OE	−	5	7	pF
I _{VDD}	Supply current	V _{DD} = 3.3V, SSCLK = 10 to 166 MHz, C _{LOAD} = 0, OE = V _{DD}	−	−	50	mA
Δf/f	Initial accuracy at room temp.	T _A = 25°C, 3.3V	−25	−	25	ppm
	Freq. stability over temp. range	T _A = −20°C to 70°C, 3.3V	−25	−	25	ppm
	Freq. stability over voltage range	3.0 to 3.6V	−12	−	12	ppm
	Aging	T _A = 25°C, First year	−5	−	5	ppm

AC Electrical Characteristics^[2]

Parameter	Description	Condition	Min	Typ	Max	Unit
DC	Output Duty Cycle	SSCLK, Measured at $V_{DD}/2$	45	50	55	%
t_R	Output Rise Time	20%–80% of V_{DD} , $C_L = 15$ pF	–	–	2.7	ns
t_F	Output Fall Time	20%–80% of V_{DD} , $C_L = 15$ pF	–	–	2.7	ns
T_{CCJ1} ^[3]	Cycle-to-Cycle Jitter SSCLK (Pin 3)	SSCLK ≥ 133 MHz, Measured at $V_{DD}/2$	–	85	200	ps
		25 MHz $\leq$ SSCLK < 133 MHz, Measured at $V_{DD}/2$	–	215	400	ps
		SSCLK < 25 MHz, Measured at $V_{DD}/2$	–	–	1% of 1/SSCK	s
T_{OE1}	Output Disable Time (pin1 = OE)	Time from falling edge on OE to stopped outputs (Asynchronous)	–	150	350	ns
T_{OE2}	Output Enable Time (pin1 = OE)	Time from rising edge on OE to outputs at a valid frequency (Asynchronous)	–	150	350	ns
T_{LOCK}	PLL Lock Time	Time for SSCLK to reach valid frequency	–	–	10	ms

Application Circuit

Figure 1. Application Circuit Diagram



Note

- Guaranteed by characterization, not fully tested.
- Jitter is configuration dependent. Actual jitter depends upon output frequencies, spread percentage, temperature, and output load. For more information, see the application note, "Jitter in PLL Based Systems: Causes, Effects, and Solutions" available at <http://www.cypress.com/clock/appnotes.html> or contact your local Cypress Field Application Engineer.

Switching Waveforms

Figure 2. Duty Cycle Waveform

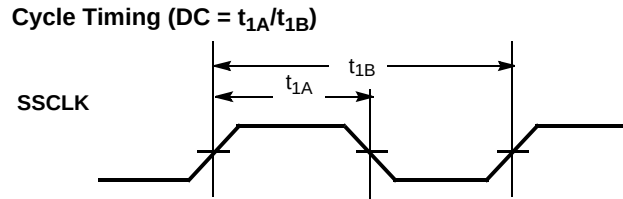


Figure 3. Output Rise/Fall Time Waveform

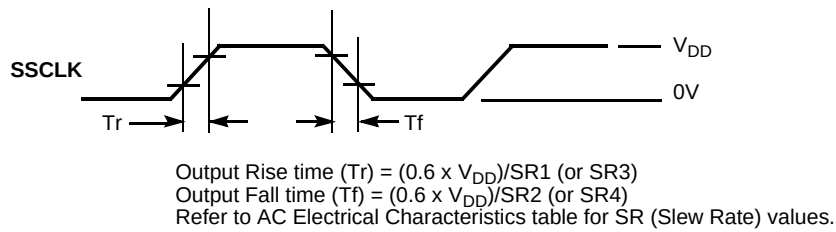
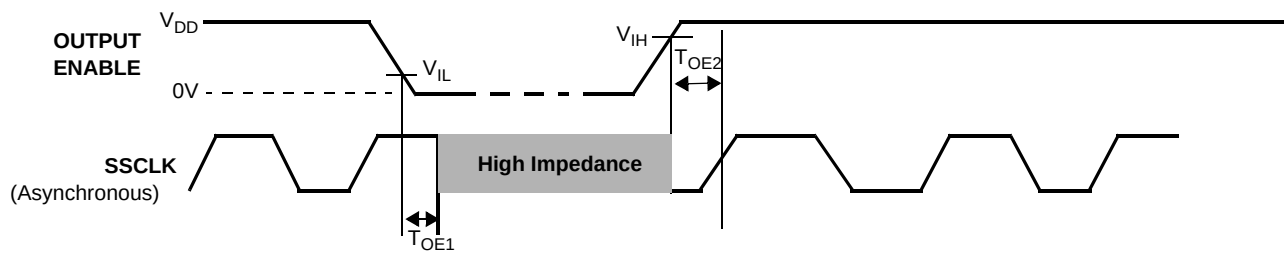
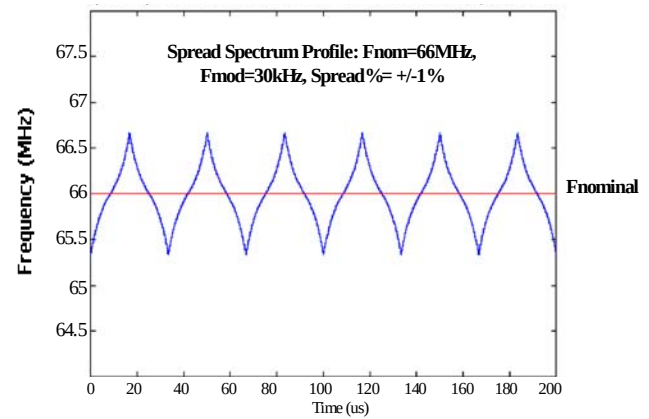
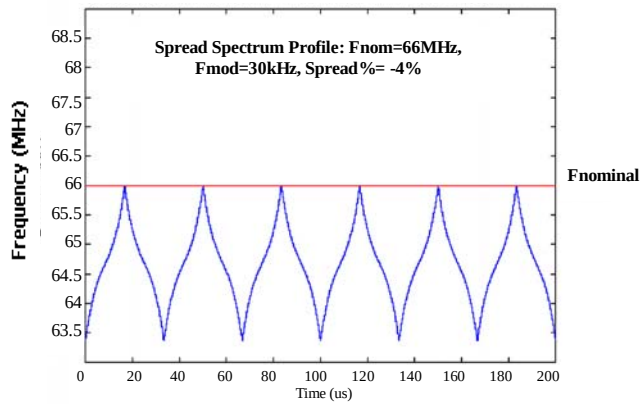
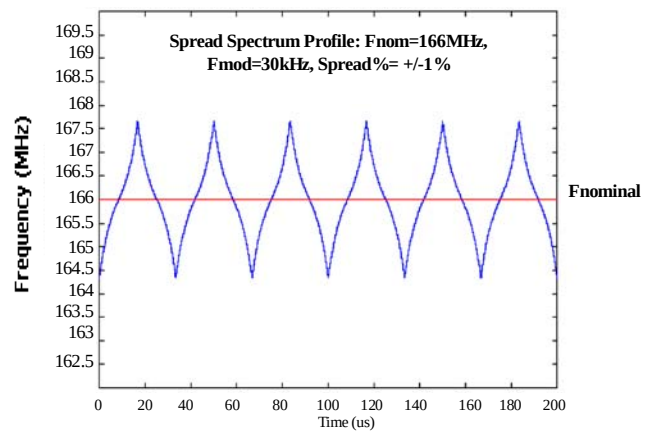
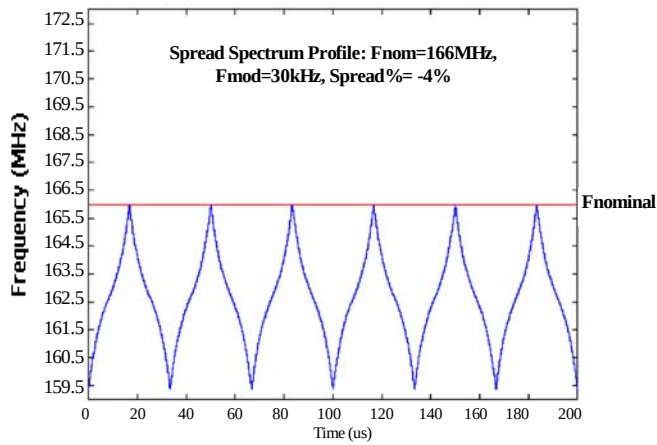


Figure 4. Output Enable/Disable Timing Waveforms



Informational Graphs^[4]



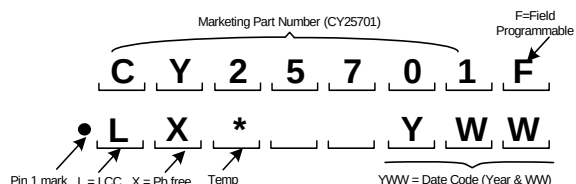
Notes

- The "Informational Graphs" are meant to convey typical performance levels. No performance specifications are implied or guaranteed. Refer to the tables on pages three and four for device specifications.

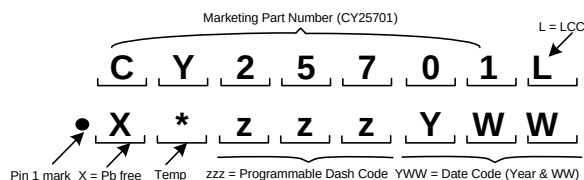
Ordering Information		
Part Number	Package Description	Product Flow
Lead-free (Pb-free)		
CY25701FLXCT ^[5]	4-Lead Ceramic LCC SMD -Tape and Reel	Commercial, -20° to 70°C
CY25701FLXIT ^[5]	4-Lead Ceramic LCC SMD -Tape and Reel	Industrial, -40° to 85°C
CY25701LXCZZZT ^[6]	4-Lead Ceramic LCC SMD -Tape and Reel	Commercial, -20° to 70°C
CY25701LXIZZT ^[6]	4-Lead Ceramic LCC SMD -Tape and Reel	Industrial, -40° to 85°C

Actual Marking^[7]

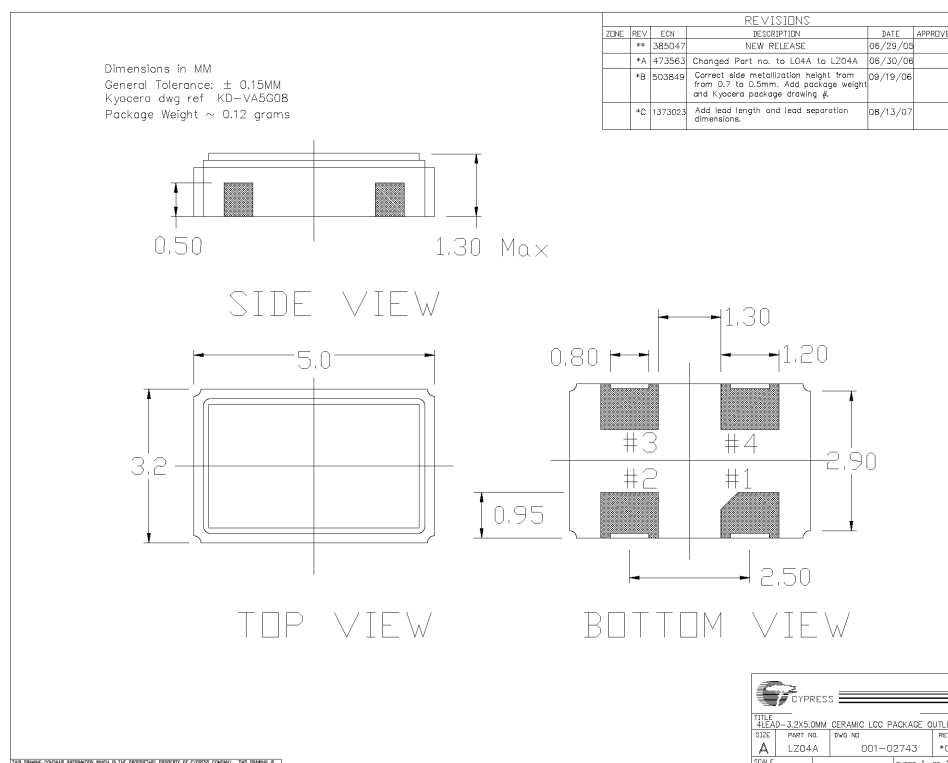
CY25701FLX*



CY25701LX*



Package Drawings and Dimensions



Notes

- "FLX" suffix is used for products programmed in the field by Cypress distributors.
- "ZZZ" denotes the assigned product dash number. This number is assigned by the factory after the output frequency and spread percent programming data is received from the customer.
- Temp can be C (Com'l) or I (Industrial).

Document History Page

Document Title: CY25701 Programmable High-frequency Crystal Oscillator with Spread Spectrum(SSXO) and No Spread Spectrum(XO) Option Document Number: 001-07313				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	442944	See ECN	RGL	New data sheet
*A	487736	See ECN	KKVTMP	Added Industrial temp
*B	1414203	See ECN	DPF/VED	Replaced the Package Drawing and Dimension figure on page seven and various copy edits; the reference to the software is now CyberClocksOn-line™ rather than CyberClocks software.

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